

Features

- High isolation 5000 VRMS
- CTR flexibility available see order information
- DC input with transistor output
- Operating temperature range - 40 °C to 100 °C
- REACH compliance
- Halogen free
- MSL class 1
- Regulatory Approvals
 - UL - UL1577
 - VDE - EN60747-5-5(VDE0884-5)
 - CQC - GB4943.1

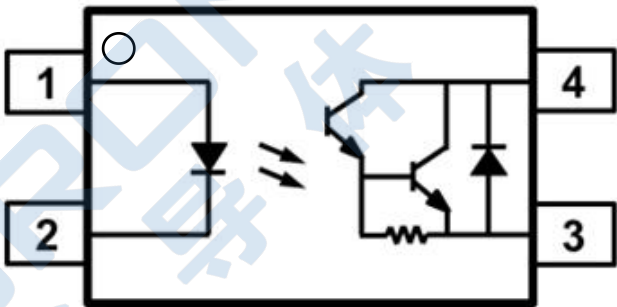
Applications

- Sequence controller
- Telephone/FAX
- System appliances, measuring instrument
- Programmable logic controller

Description

The ICPL-852 series combine an AlGaAs infrared emitting diode as the emitter which is optically coupled to a silicon planar darlington phototransistor detector in a plastic DIP4 package with different lead forming options.

With the robust coplanar double mold structure, ICPL-852 series provide the most stable isolation feature.



ORDERING INFORMATION

Outline	Part Number	Package	Marking	Packing	Packing Size	Quantity
	ICPL-852-010E	DIP4	ICPL 852 /YYWW A	Tube	500mm	100
	ICPL-852-110E	DIP4-M		Tube	500mm	100
	ICPL-852-510E	DIP4-SL		Reel	13 "	1000

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PIN CONFIGURATION AND FUNCTIONS

	Pin	Name
	1	Anode
	2	Cathode
	3	Emitter
	4	Collector

ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Value	Unit	Note
INPUT				
Forward Current	I_F	60	mA	
Peak Forward Current	I_{FP}	1	A	1
Reverse Voltage	V_R	6	V	
Input Power Dissipation	P_I	100	mW	
OUTPUT				
Collector - Emitter Voltage	V_{CEO}	350	V	
Emitter - Collector Voltage	V_{ECO}	0.1	V	
Collector Current	I_C	150	mA	
Output Power Dissipation	P_O	150	mW	
COMMON				
Total Power Dissipation	P_{tot}	200	mW	
Isolation Voltage	V_{iso}	5000	Vrms	2
Operating Temperature	T_{opr}	-40~100	°C	
Storage Temperature	T_{stg}	-55~125	°C	
Soldering Temperature	T_{sol}	260	°C	

Note 1. 100μs pulse, 100Hz frequency
Note 2. AC For 1 Minute, R.H. = 40 ~ 60%

ELECTRICAL OPTICAL CHARACTERISTICS(T_a=25°C)

Parameter	Symbol	Min	Typ.	Max.	Unit	Test Condition	Note
INPUT							
Forward Voltage	V _F	-	1.24	1.4	V	I _F =10mA	
Reverse Current	I _R	-	-	10	μA	V _R =6V	
Input Capacitance	C _{in}	-	10	-	pF	V=0, f=1kHz	
OUTPUT							
Collector Dark Current	I _{CEO}	-	-	200	nA	V _{CE} =200V, I _F =0	
Collector-Emitter Breakdown Voltage	BV _{CEO}	350	-	-	V	I _C =0.1mA, I _F =0	
Emitter-Collector Breakdown Voltage	BV _{ECO}	0.1	-	-	V	I _E =0.1mA, I _F =0	
TRANSFER CHARACTERISTICS							
Current Transfer Ratio	CTR	1000	-	15000	%	I _F =1mA, V _{CE} =2V	
Collector-Emitter Saturation Voltage	V _{CE(sat)}	-	-	1.2	V	I _F =20mA, I _C =100mA	
Isolation Resistance	R _{ISO}	10 ¹²	10 ¹⁴	-	Ω	DC500V, 40 ~ 60% R.H.	
Floating Capacitance	C _{IO}	-	0.6	1	pF	V=0, f=1MHz	
Response Time (Rise)	t _r	-	3	18	μs	V _{CE} =2V, I _C =2mA R _L =100Ω	3
Response Time (Fall)	t _f	-	4	18	μs		3
Cut-off Frequency	f _c	-	80	-	kHz	V _{CE} =2V, I _C =2mA R _L =100Ω, -3dB	4

Note 3. Fig.12&13

Note 4. Fig.14

CHARACTERISTIC CURVES

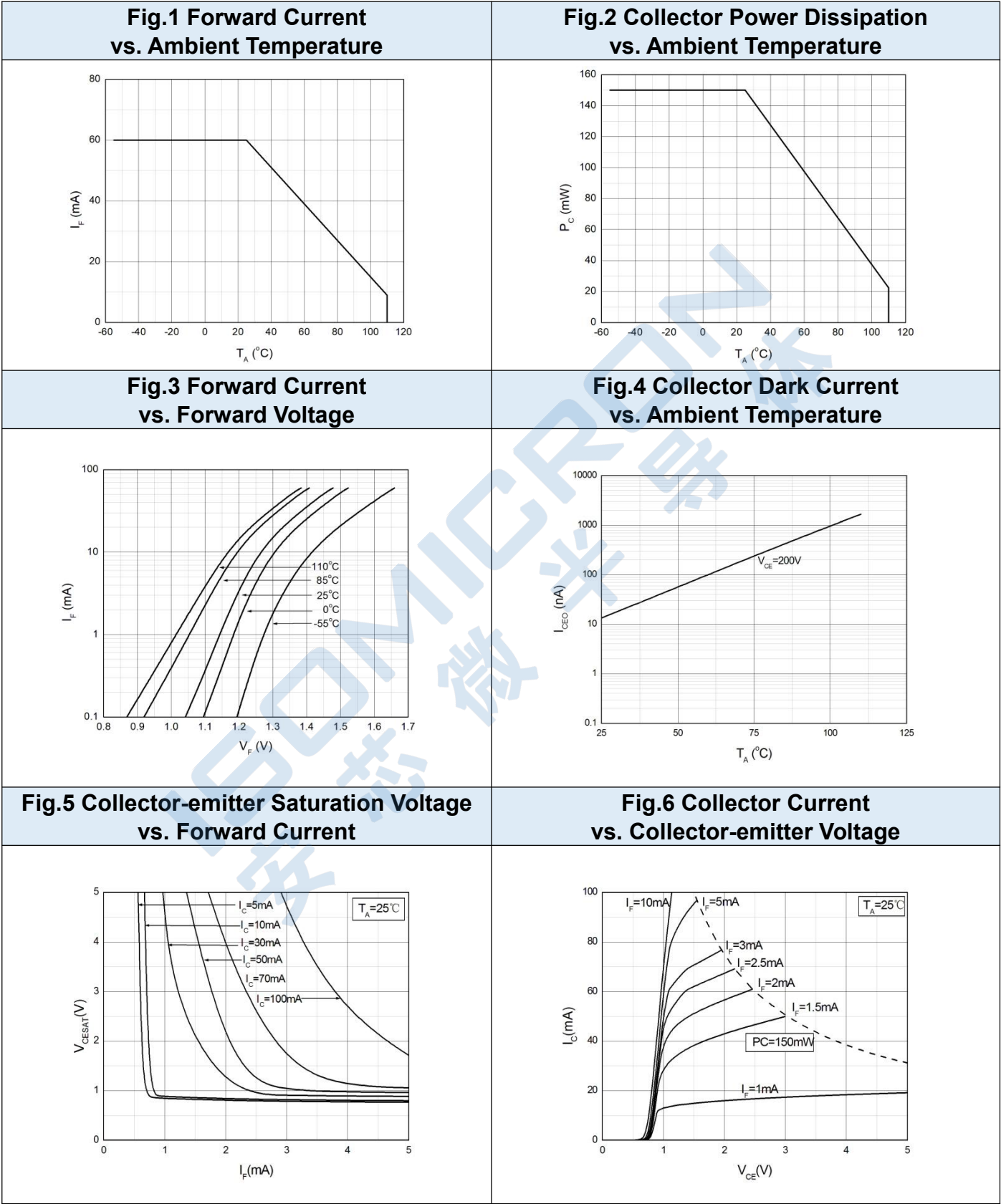


Fig.7 Normalized Current Transfer Ratio
vs. Forward Current

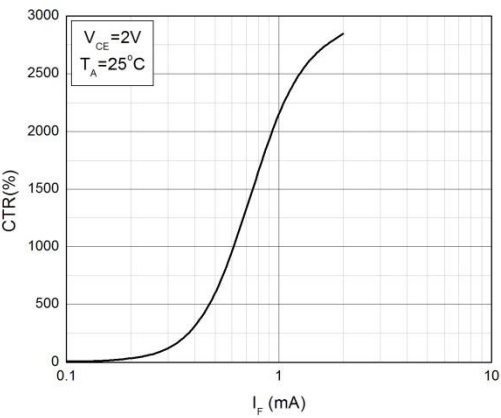


Fig.8 Normalized Current Transfer Ratio
vs. Ambient Temperature

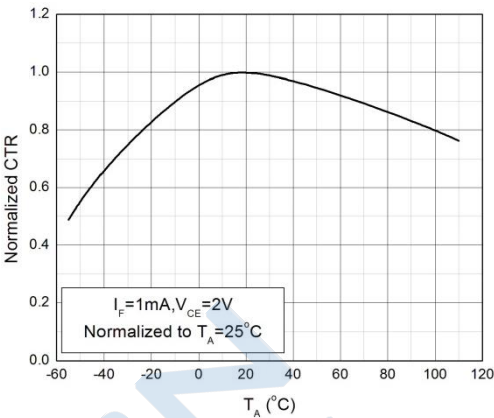


Fig.9 Collector-emitter Saturation Voltage
vs. Ambient Temperature

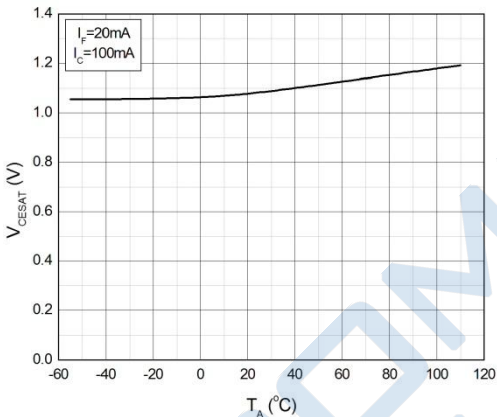


Fig.10 Switching Time
vs. Load Resistance

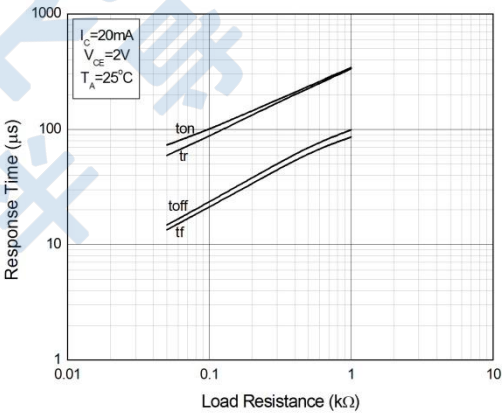
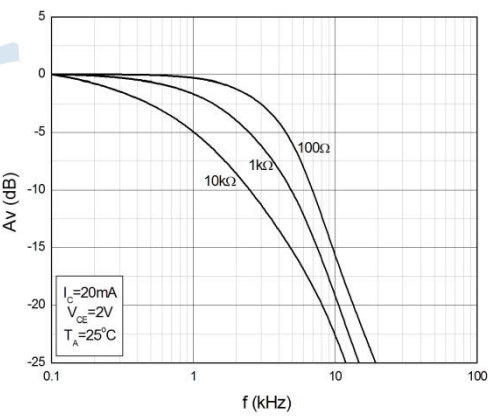
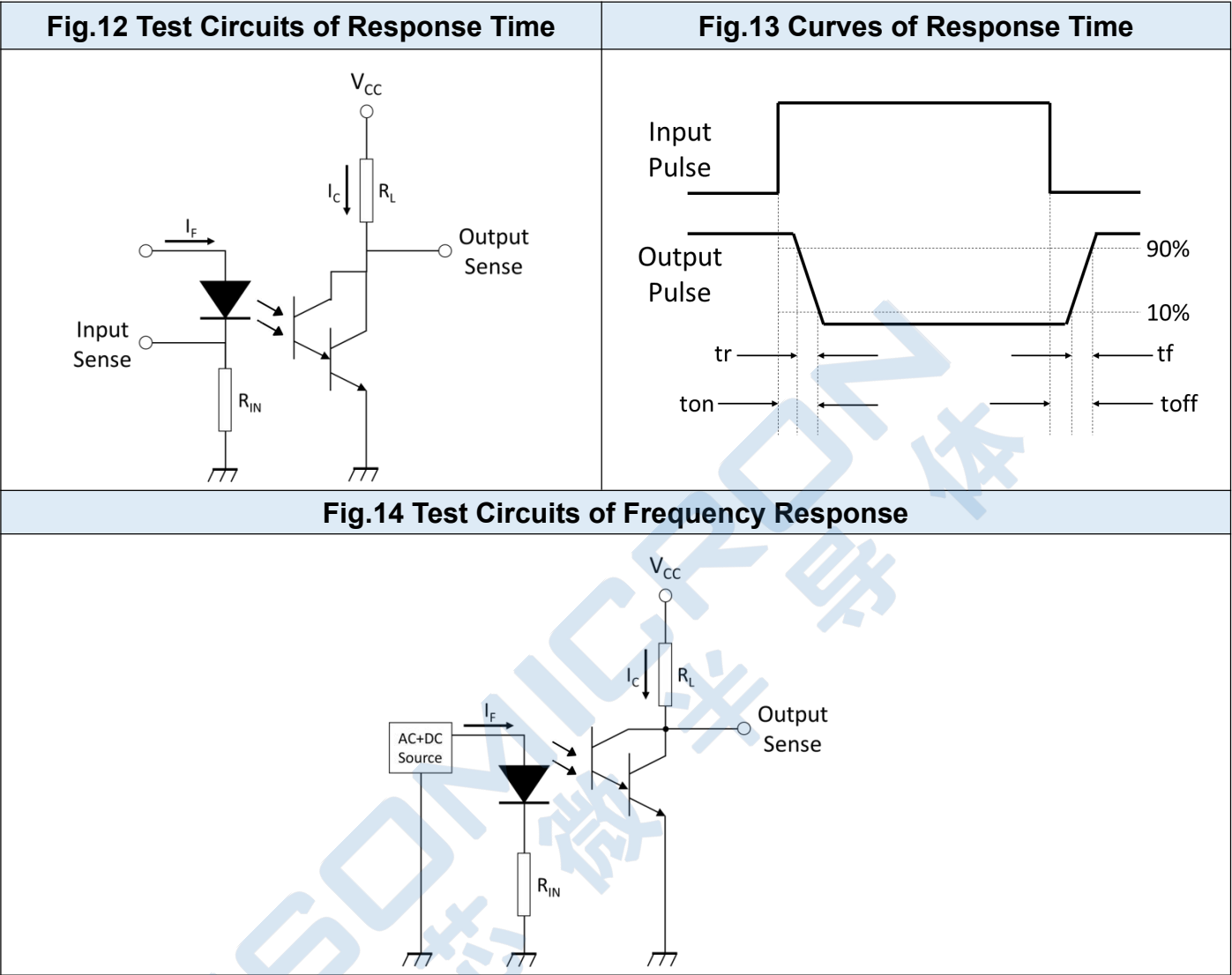


Fig.11 Frequency Response

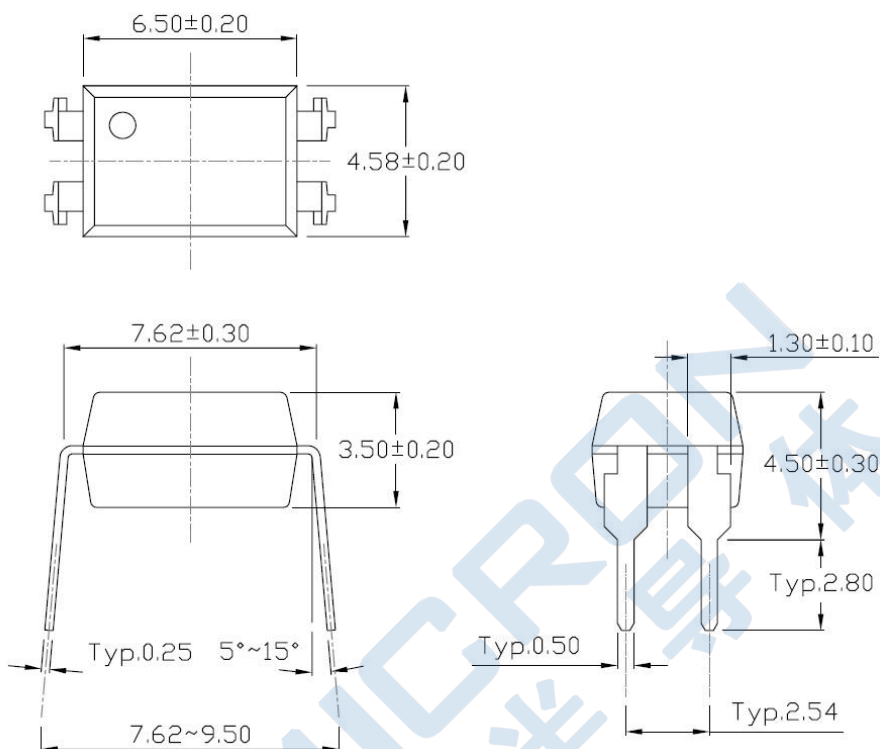


TEST CIRCUITS

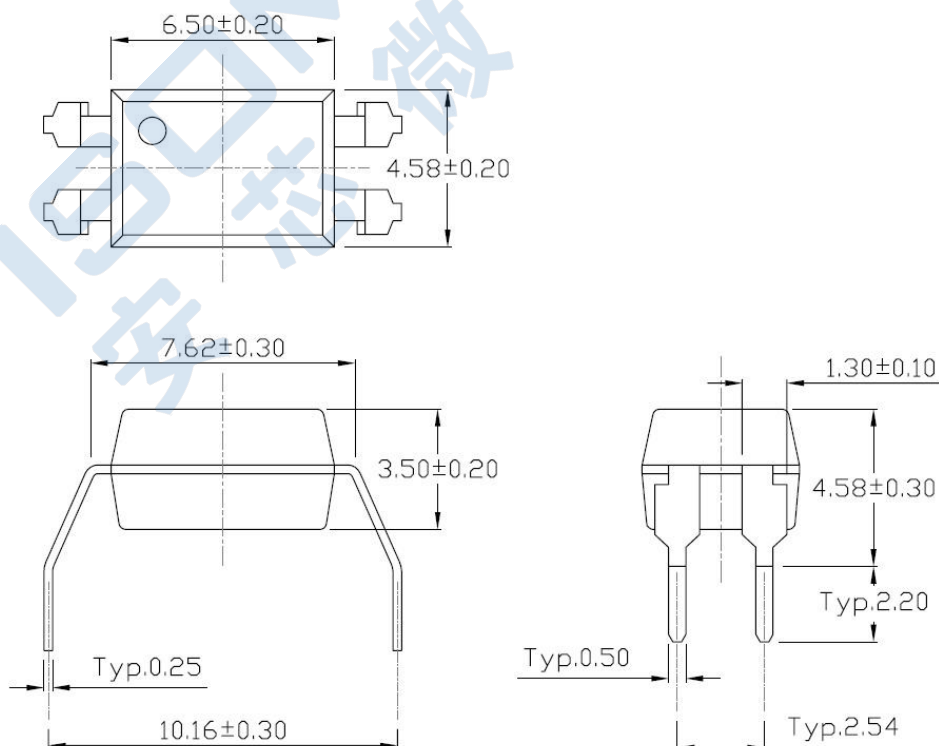


PACKAGE DIMENSIONS

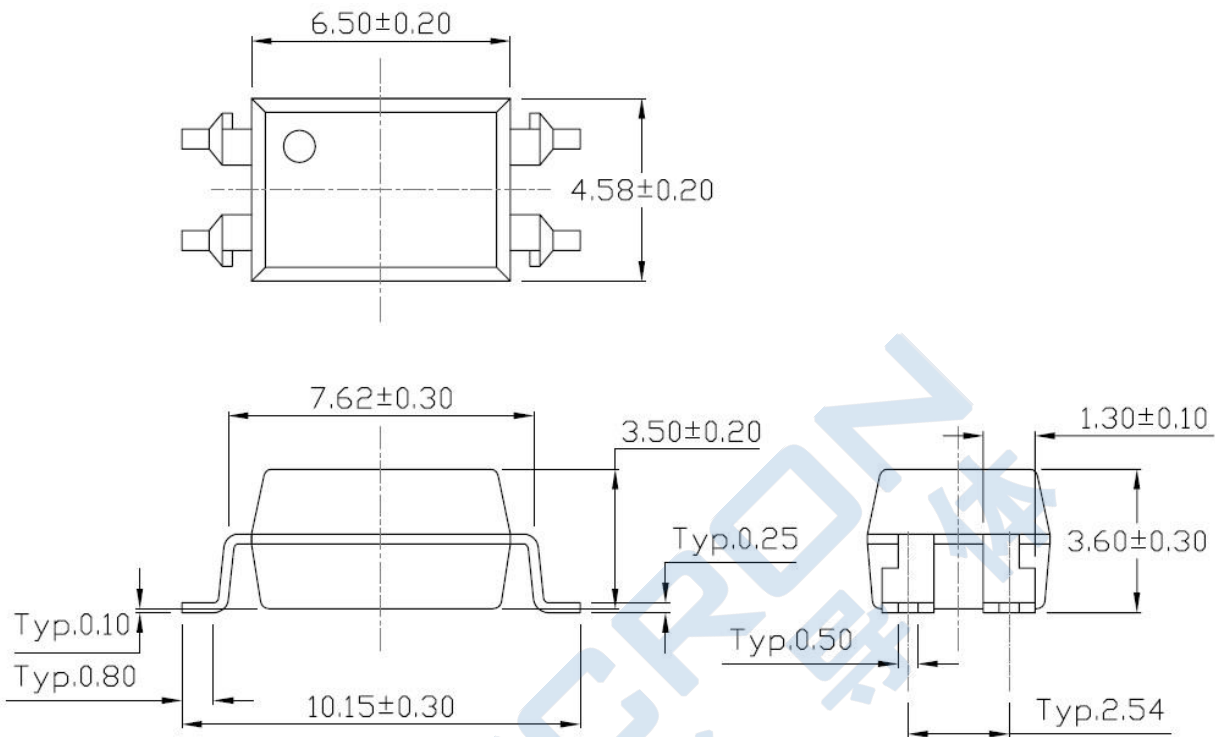
Standard DIP – Through Hole (DIP Type)



Gullwing (400mil) Lead Forming – Through Hole (M Type)



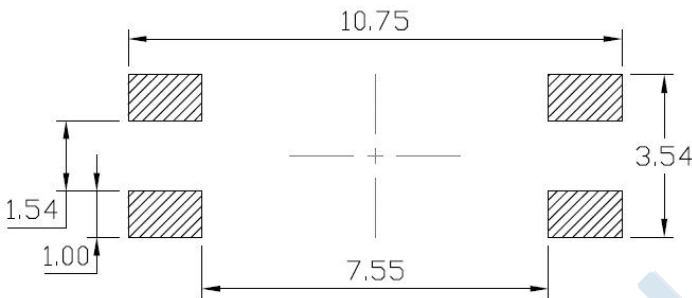
Surface Mount (Low Profile) Lead Forming (SL Type)



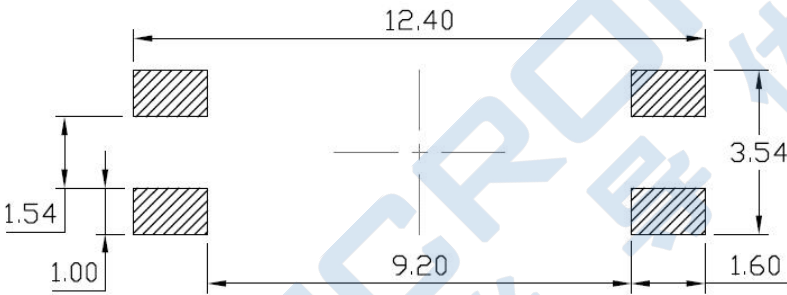
- Dimensions in mm unless otherwise stated

RECOMMENDED SOLDER MASK

Surface Mount (Low Profile) Lead Forming



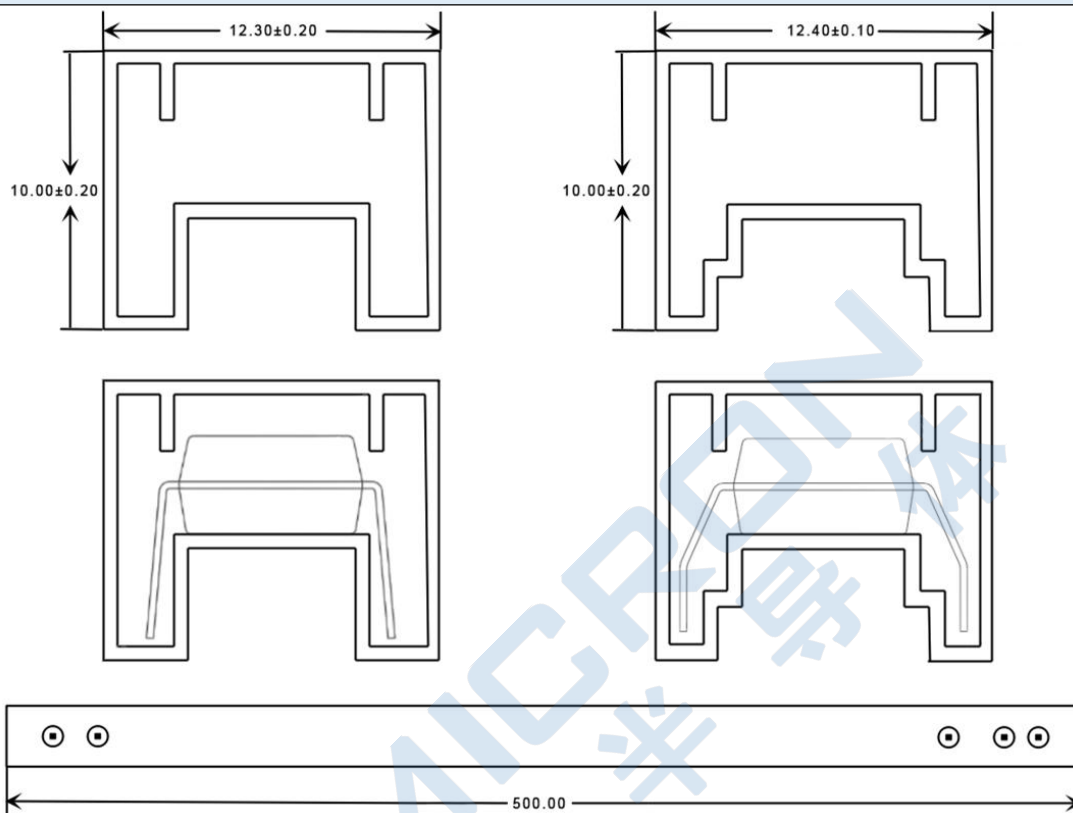
Surface Mount (Gullwing) Lead Forming



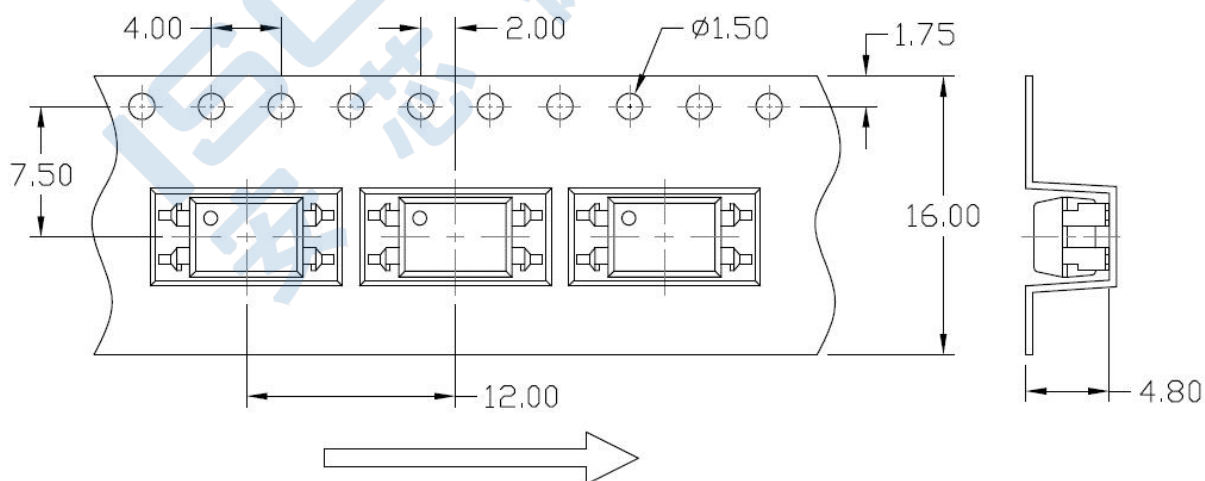
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CARRIER TAPE SPECIFICATIONS

Option DIP-Standard & DIP-M



Option SM-SL



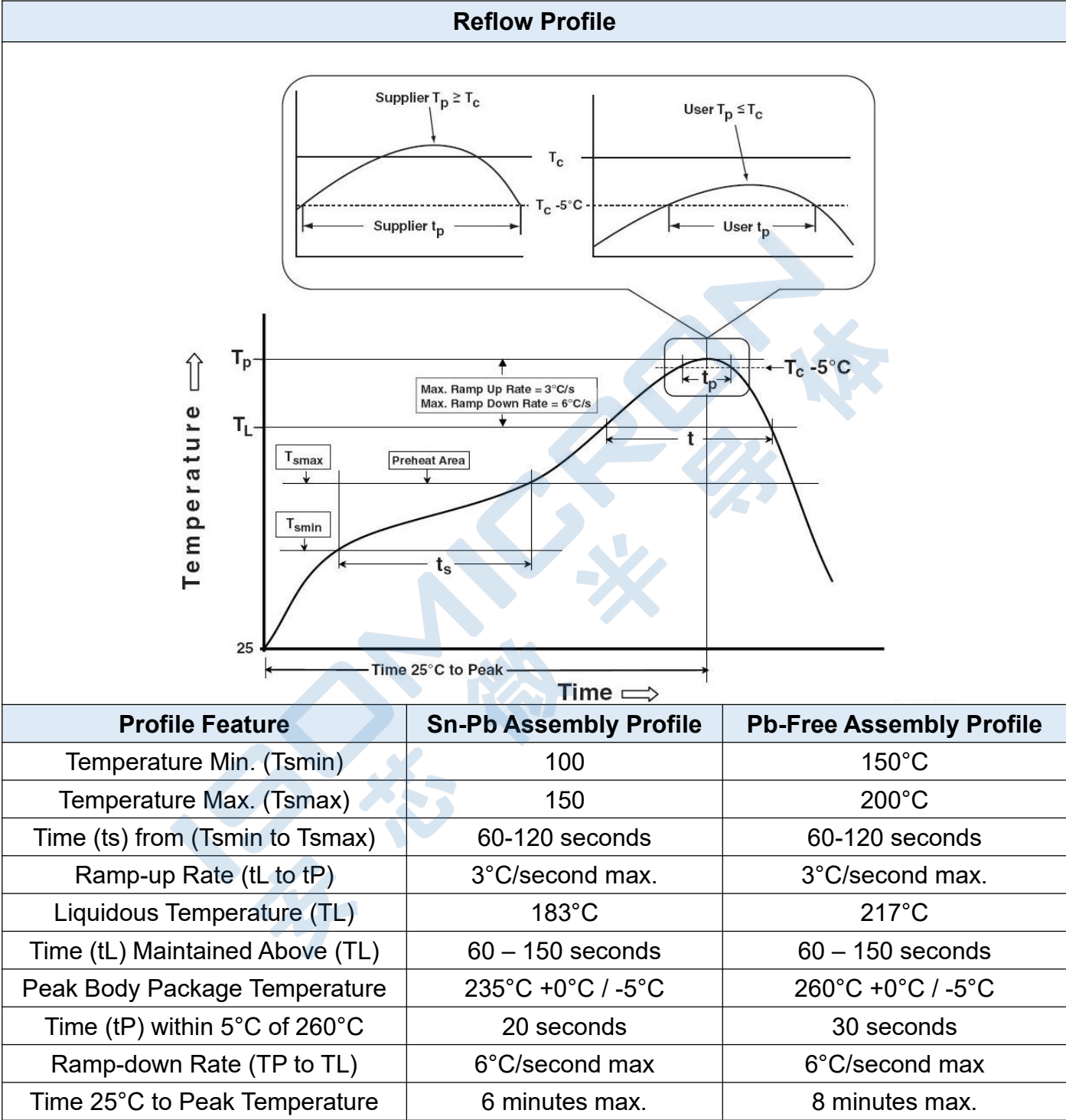
- Dimensions in mm unless otherwise stated

ISOMICRON
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ORDERING AND MARKING INFORMATION

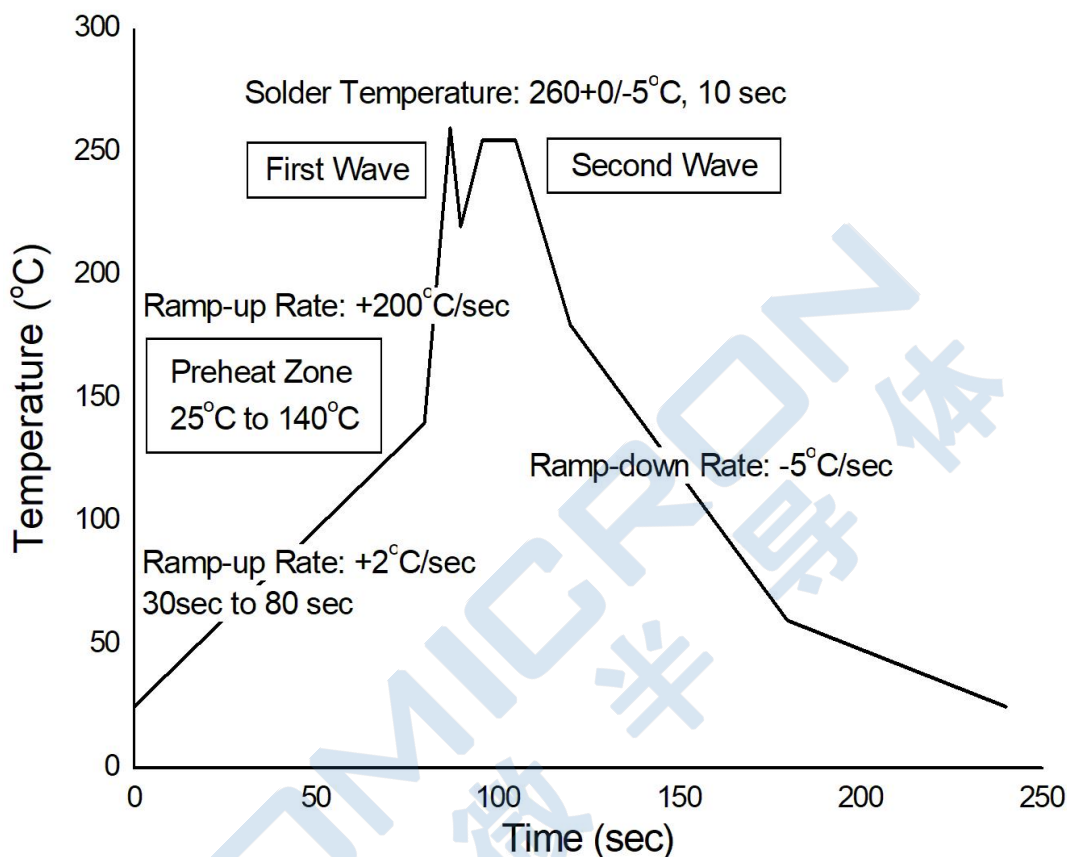
Marking Information			
		ICPL : Company Abbr. 852 : Part Number / : ISOMICRON YY : Fiscal Year WW : Work Week A : Manufacturing Code	
Order Code			
ICPL - 852 - 5 1 0 E Company Abbr. Part Number Lead Forming: 0: DIP-Standard 1: DIP-M 5: SM-SL Halogen Free: E: Halogen-free,Lead-free Z: Halogen, Lead-free CTR Rank: None Performance: 0: Normal 1: Enhanced			
Packing Quantity			
Option	Quantity	Quantity – Inner box	Quantity – Outer box
DIP-Standard	100 Units/Tube	20 Tubes/Inner box	6 Inner box/Outer box = 12k Units
DIP-M	100 Units/Tube	20 Tubes/Inner box	6 Inner box/Outer box = 12k Units
SM-SL	1000 Units/Reel	2 Reels/Inner box	5 Inner box/Outer box = 10k Units

REFLOW INFORMATION



TEMPERATURE PROFILE OF SOLDERING

Wave Soldering (JESD22-A111 Compliant)



Hand Soldering By Soldering Iron

Soldering Temperature	$380+0/-5^{\circ}\text{C}$
Soldering Time	3 sec max.

- One time soldering is recommended for all soldering method.
- Do not solder more than three times for IR reflow soldering.

DISCLAIMER

- ISOMICRON is continually improving the quality, reliability, function and design. ISOMICRON reserves the right to make changes without further notices.
- The characteristic curves shown in this datasheet are representing typical performance which are not guaranteed.
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- This product is not intended to be used for military, aircraft, automotive, medical, life sustaining or lifesaving applications or any other application which can result in human injury or death.
- Please contact ISOMICRON sales agent for special application request.
- Immerge unit's body in solder paste is not recommended.
- Parameters provided in datasheets may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated in each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify ISOMICRON's terms and conditions of purchase, including but not limited to the warranty expressed therein.
- Discoloration might be occurred on the package surface after soldering, reflow or long-time use. It neither impacts the performance nor reliability.